Special Issue

Emerging Technologies in Heating, Ventilation, Air Conditioning and Refrigeration (HVAC&R) Systems (Second Volume)

Message from the Guest Editors

This Special Issue on "Emerging Technologies in Heating, Ventilation, Air Conditioning and Refrigeration (HVAC&R) Systems" aims to collect and report novel technologies and advances in HVAC&R. Topics include, but are not limited to:

- Advanced HVAC&R systems and equipment
- Thermodynamics analysis and energy systems for HVAC&R
- Novel HVAC&R systems and processes
- Indoor environmental quality management
- Experiments and analysis for HVAC&R
- Simulation approaches and new algorithms for HVAC&R
- Novel refrigerants and applications
- Energy efficiency analysis and improvement for HVAC&R
- Intensive review article on the state-of-the-art of HVAC&R

Guest Editors

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Dr. Ming-Tsang Lee

Deadline for manuscript submissions

closed (20 July 2023)



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